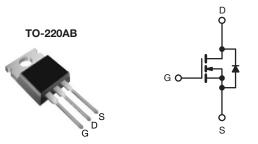


Power MOSFET

PRODUCT SUMMARY					
V _{DS} (V) at T _J max.	560				
R _{DS(on)} (Ω)	V _{GS} = 10 V	0.225			
Q _g (Max.) (nC)	76				
Q _{gs} (nC)	21				
Q _{gd} (nC)	29				
Configuration	Single				



N-Channel MOSFET

FEATURES

- Low Figure-of-Merit Ron x Qq
- 100 % Avalanche Tested
- High Peak Current Capability
- dV/dt Ruggedness
- Improved t_{rr}/Q_{rr}
- Improved Gate Charge
- High Power Dissipations Capability
- Compliant to RoHS Directive 2002/95/EC



ORDERING INFORMATION				
Package	TO-220AB			
Lead (Pb)-free	SiHP18N50C-E3			

ABSOLUTE MAXIMUM RATINGS (T _C = 25 °C, unless otherwise noted)							
PARAMETER			SYMBOL	LIMIT	UNIT		
Drain-Source Voltage			V _{DS}	500	V		
Gate-Source Voltage			V_{GS}	± 30	v		
Continuous Drain Current (T _J = 150 °C) ^a	V _{GS} at 10 V	$T_{\rm C} = 25 ^{\circ}{\rm C}$ $T_{\rm C} = 100 ^{\circ}{\rm C}$	- I _D	18	А		
		T _C = 100 °C		11			
Pulsed Drain Current ^b			I _{DM}	72			
Linear Derating Factor	TO-220AB			1.8	W/°C		
Single Pulse Avalanche Energy ^c			E _{AS}	361	mJ		
Maximum Power Dissipation TO-220AB		P_{D}	223	W			
Peak Diode Recovery dV/dt ^d			dV/dt	5	V/ns		
Operating Junction and Storage Temperature Range			T _J , T _{stg}	- 55 to + 150	°C		
Soldering Recommendations (Peak Temperature) ^d	for 10 s			300]		

- a. Drain current limited by maximum junction temperature.
- b. Repetitive rating; pulse width limited by maximum junction temperature.
- c. V_{DD} = 50 V, starting T_J = 25 °C, L = 2.5 mH, R_g = 25 Ω , I_{AS} = 17 A.
- d. $I_{SD} \le 18$ A, $dI/dt \le 380$ A/µs, $V_{DD} \le V_{DS}$, $T_J \le 150$ °C.
- e. 1.6 mm from case.

^{*} Pb containing terminations are not RoHS compliant, exemptions may apply



THERMAL RESISTANCE RATINGS						
PARAMETER		SYMBOL	TYP.	MAX.	UNIT	
Maximum Junction-to-Ambient	TO-220	R _{thJA}	-	62	°C/W	
Maximum Junction-to-Case (Drain)	TO-220	R_{thJC}	-	0.56	- C/VV	

PARAMETER	SYMBOL	TES	MIN.	TYP.	MAX.	UNIT	
Static				L		L	
Drain-Source Breakdown Voltage	V_{DS}	V _{GS}	= 0 V, I _D = 250 μA	500	-	-	V
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Referenc	e to 25 °C, I _D = 1 mA	-	0.6	-	V/°C
Gate-Source Threshold Voltage (N)	V _{GS(th)}	V _{DS} :	$V_{DS} = V_{GS}, I_D = 250 \mu A$		-	5.0	V
Gate-Source Leakage	I _{GSS}		V _{GS} = ± 30 V	-	-	± 100	nA
Zava Cata Valtaga Dvain Coverent	1	V _{DS} = 500 V, V _{GS} = 0 V		-	-	25	μА
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = 400 \	V _{DS} = 400 V, V _{GS} = 0 V, T _J = 125 °C		-	250	
Drain-Source On-State Resistance	R _{DS(on)}	V _{GS} = 10 V	I _D = 10 A	-	0.225	0.270	Ω
Forward Transconductance ^a	9 _{fs}	V _{DS} = 50 V, I _D = 10 A		-	6.4	-	S
Dynamic							
Input Capacitance	C _{iss}	$V_{GS} = 0 \text{ V},$ $V_{DS} = 25 \text{ V},$			2451	2942	pF
Output Capacitance	C _{oss}			-	300	360	
Reverse Transfer Capacitance	C _{rss}	f = 1.0 MHz		=.	26	32	
Internal Gate Resistance	R _g	f = 1.0 MHz, open drain		-	1.1	-	Ω
Total Gate Charge	Q_g				65	76	
Gate-Source Charge	Q _{gs}	V _{GS} = 10 V	V _{GS} = 10 V	=.	21	=.	nC
Gate-Drain Charge	Q _{gd}	1		-	29	-	
Turn-On Delay Time	t _{d(on)}	$V_{DD} = 250 \text{ V}, I_{D} = 18 \text{ A}$ $R_{g} = 7.5 \Omega, V_{GS} = 10 \text{ V}$		-	80	=.	ns ns
Rise Time	t _r			-	27	-	
Turn-Off Delay Time	t _{d(off)}			=.	32	=.	
Fall Time	t _f			-	44	-	
Drain-Source Body Diode Characteristic	s						
Continuous Source-Drain Diode Current	I _S	MOSFET symbol showing the		-	-	18	
Pulsed Diode Forward Current	I _{SM}	integral reverse p - n junction diode		-	-	72	- A
Body Diode Voltage	V _{SD}	T _J = 25 °C, I _S = 18 A, V _{GS} = 0 V		-	-	1.5	V
Body Diode Reverse Recovery Time	t _{rr}	$T_J = 25 ^{\circ}\text{C}, I_F = I_S,$ $dI/dt = 100 \text{A/}\mu\text{s}, V_R = 35 \text{V}$		-	503	-	ns
Body Diode Reverse Recovery Charge	Q _{rr}			-	6.7	-	μC
Reverse Recovery Current	I _{RRM}			-	30	-	Α

Note

The information shown here is a preliminary product proposal, not a commercial product datasheet. Vishay Siliconix is not committed to produce this or any similar product. This information should not be used for design purposes, nor construed as an offer to furnish or sell such products.

a. Repetitive rating; pulse width limited by maximum junction temperature.



TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

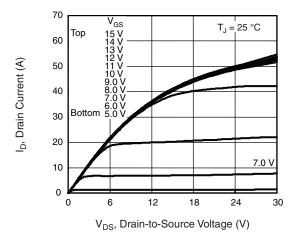


Fig. 1 - Typical Output Characteristics, T_C = 150 °C

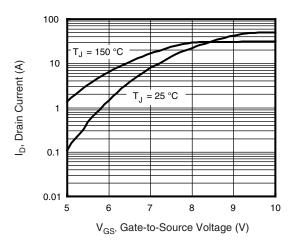


Fig. 3 - Typical Transfer Characteristics

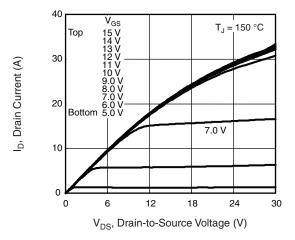


Fig. 2 - Typical Output Characteristics, T_C = 150 °C

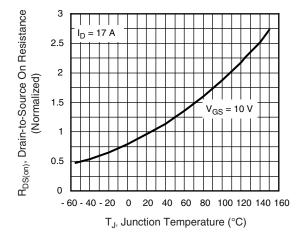


Fig. 4 - Normalized On-Resistance vs. Temperature



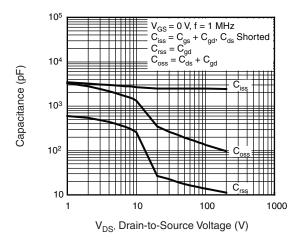


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

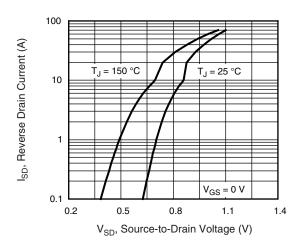


Fig. 7 - Typical Source-Drain Diode Forward Voltage

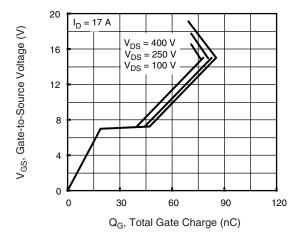


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

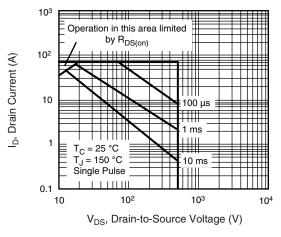


Fig. 8 - Maximum Safe Operating Area

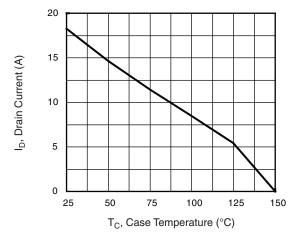


Fig. 9 - Maximum Drain Current vs. Case Temperature



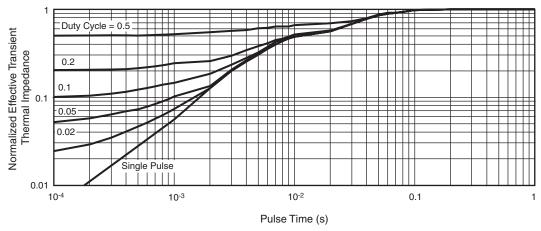


Fig. 10 - Normalized Thermal Transient Impedance, Junction-to-Case

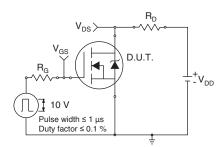


Fig. 11a - Switching Time Test Circuit

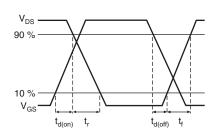


Fig. 11b - Switching Time Waveforms

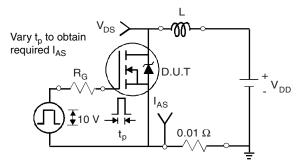


Fig. 12a - Unclamped Inductive Test Circuit

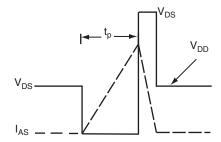


Fig. 12b - Unclamped Inductive Waveforms

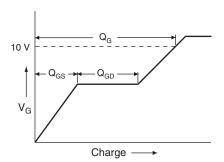


Fig. 13a - Basic Gate Charge Waveform

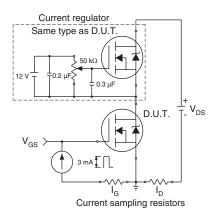
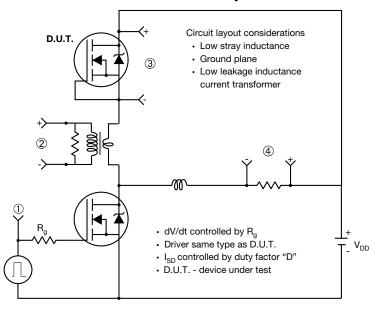


Fig. 13b - Gate Charge Test Circuit



Peak Diode Recovery dV/dt Test Circuit



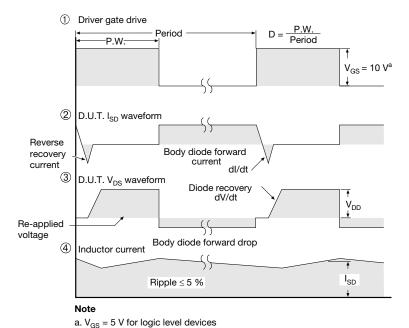


Fig. 14 - For N-Channel

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